

REPLACEMENT SHEET
"LAYERED SUPPORT AND METHOD FOR LAMINATING CMP PADS"

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Application No. 10/754,381

Sheet 2 of 7

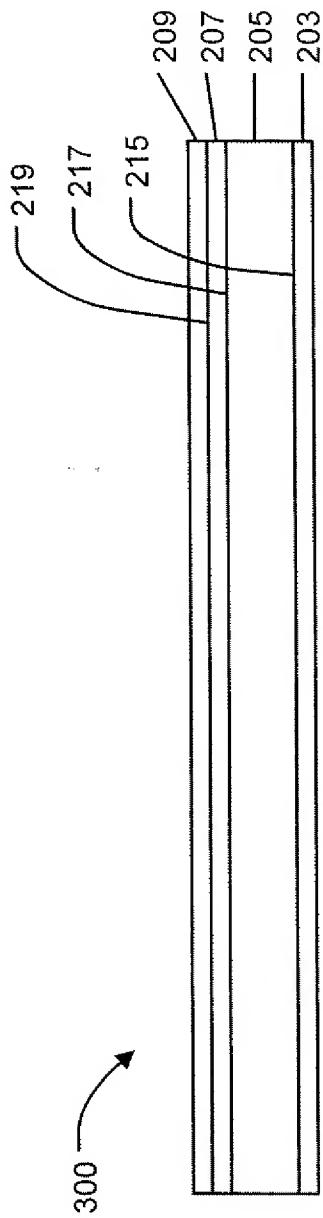


FIG. 3A

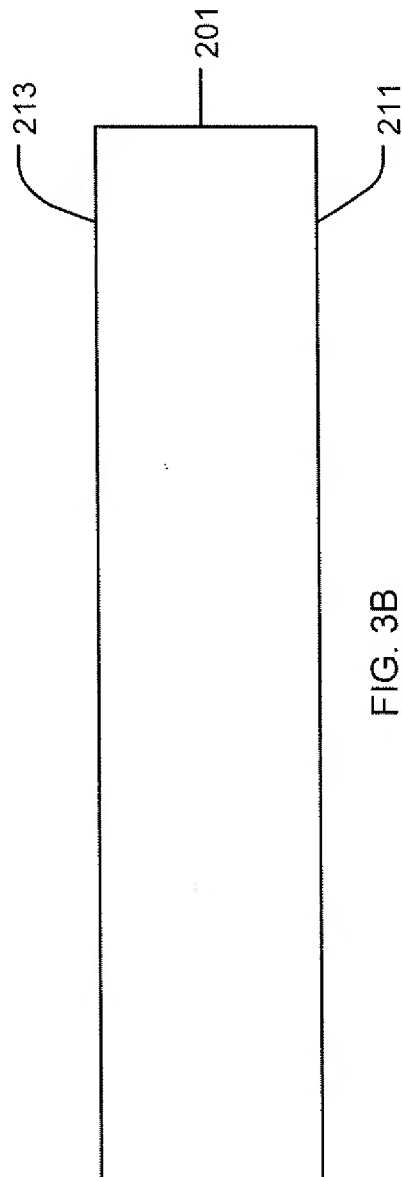


FIG. 3B

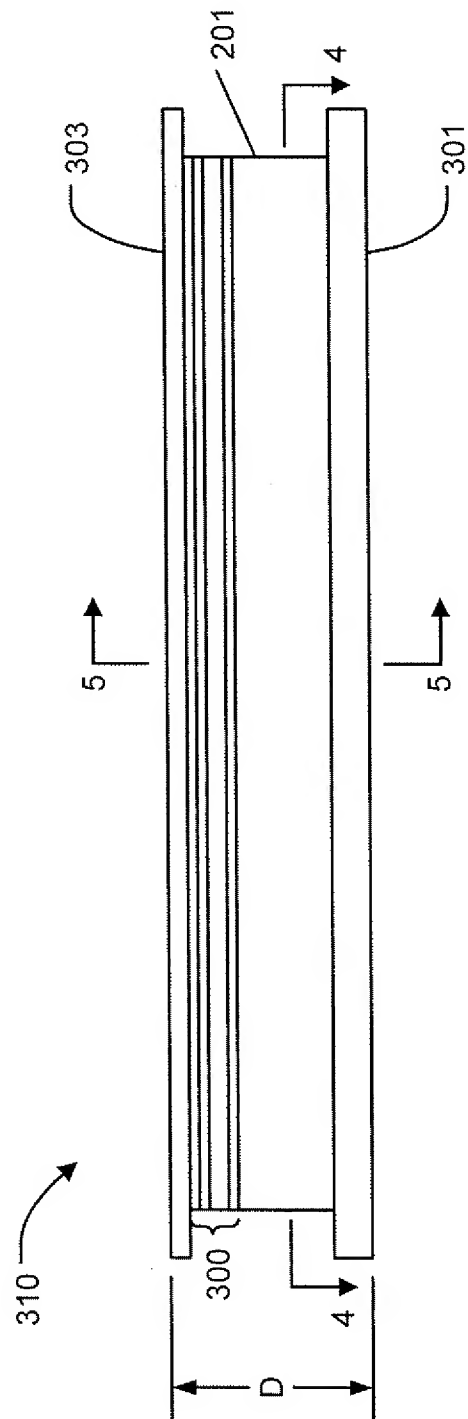


FIG. 3C